

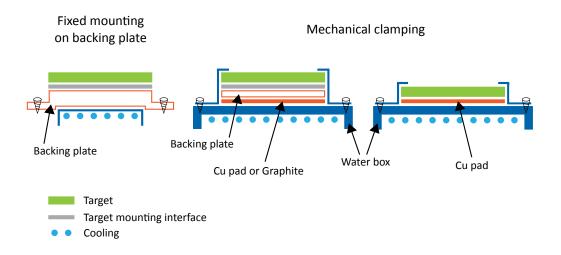


materials SPUTTERING TARGETS

• Mounting of Sputtering Targets..... D 21



Mounting of Sputtering Targets



MAIN MOUNTING CHARACTERISTICS

		ADHESIVE MOUNTING			MECHANICAL MOUNTING		
	Ag	In	InSnPb	Elastomeric	Elastomeric + Cu	Graphite Foil	Cu Pad
DC	••	•	•••	-	• • •	••	•••
RF	•••	•••	••	•	• • •	• •	• • •
High power DC >5 W/cm ²	•	•	•••	-	•	••	• • •
High power RF >3 W/cm ²	••	••	••	•	• •	• •	•••
Easy mounting	•	•	-	• • •	• •	•••	•••
Temperature compatibility	•	•	••	••	• • •	•••	•••
Mechanical adjustment	••	••	-	-	-	-	•••
Low cost	• •	-	-		• • •	• • •	•••



TARGET MOUNTING IN NEYCO'S LABORATORY

Neyco offers a complete target bonding service on new or existing backing plates:

- Debonding or debrazing of your target
- Backing plate cleaning
- Target bonding: Cu/elastomeric bonding (200°C) or silver based mounting (150°C)
- Cleaning and packaging of the assembly with UHV quality



	ADVANTAGES	DISADVANTAGES
Cu based bonding	 Low price Very good thermal and electrical conductivities Excellent adhesion between many metals Suitable for low melting point target materials Suitable especially for fragile targets 	 No mechanical adaptation
Ag based bonding	 All types of targets, including very fragile Good thermal and electrical conductivities Mechanical adjustment up to 0.4 mm 	 The cost of Ag metal Degrades over 150°C

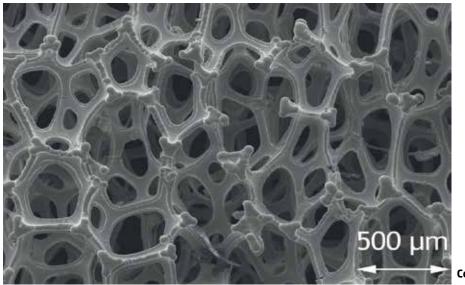
COPPER PADS FOR SPUTTERING

NEYCO has developed sputtering pads, as a replacement of Indium, Graphite foils or other bondings, for clamped targets.

ADVANTAGES	DISADVANTAGES
 Excellent thermal and electrical conductivities High DC and RF power Low cost Mechanical adjustment up to 0.5 mm 	 Only for clamped targets

CHARACTERISTICS

- 100% metallic
- Initial thickness 2 mm
- Purity 99.95+%
- Vacuum packed for a direct mounting in secondary vacuum
- 200 mm wide x length on request (up to 1000 mm)
- HV compatible



Copper foam pad

GRAPHITE PADS FOR SPUTTERING

NEYCO offers you Graphite pads for sputtering. The size from ~500 mm wide x length on request. Thickness of 0.2 mm.

ADVANTAGES	DISADVANTAGES
 Good thermal and electrical conductivities Enabling high DC and RF power Temperature > 250°C Low cost 	 Only for clamped targets No mechanical adjustment

SILVER-FILLED EPOXY BONDING CEMENT

Silver-filled epoxy cement is a silver-colored thick paste containing the optimum ratio of silver powder to epoxy resin for maximum thermal and electrical conductivity and mechanical strength. The catalyst is a clear to yellow liquid. Both the epoxy cement and the catalyst should be stored in a refrigerator. This will give a shelf life of 6 months.

TYPICAL PROPERTIES OF EPOXY

Volume resistivity	Less than 0.001 Ω.cm
Pot life (after catalyst addition)	30 min at 25℃
Use temperature	-50°C to 115°C
Packaging	114 g





30 avenue de la Paix 92170 Vanves - France Tel: +33(0)1 41 90 50 50 Fax: +33(0)1 41 90 50 51

www.neyco.fr



Materials D 2018-1

